

Waterproof MEMS Microphone with Top Port and Analog Output

DESCRIPTION

The ZTS6411 is a high quality, low cost, low power analog output top-ported omni-directional MEMS microphone. ZTS6411 consists of a MEMS microphone element and an preamplifier. ZTS6411 has a high SNR and flat wideband frequency response, resulting in natural sound with high intelligibility. Extra EMI filter for RF noise attenuation is built inside. Due to the built-in filter, ZTS6411 shows high immunity to EMI.

The ZTS6411 is available in a thin 3.76mm × 2.95mm × 1.3mm surface-mount package. It is reflow solder compatible with no sensitivity degradation. The ZTS6411 is halide free.

FEATURES

- 3.76mm×2.95mm×1.3mm surface-mount package
- Stable sensitivity over power supply range of 1.5V-3.6V
- SNR of 59dBA
- Sensitivity of -42dBV
- Low current consumption of $< 200 \mu A$
- Multi Chip Module (MCM) Package
- IP68 compatible

Pins Configuration and Description



Typical Applications

The ZTS6411 output can be connected to a codec microphone input or to a high input impedance gain stage. A dc-blocking capacitor is required at the output of the microphone.



Absolute Maximum Ratings

Supply Voltage	–0.5V to +4V
Sound Pressure Level	160dB
Mechanical Shock	10000g
Vibration	Per MIL-STD-883 Method
	2007, Test Condition B
Temperature Range	40°C to +100°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electro-Static Discharge Sensitivity

This integrated circuit can be damaged by ESD. It is recommended that all integrated circuits be handled with proper precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure.

Pins Description

Pin	Symbol	Description			
1	VDD	Power Supply.			
2,3	GND	Ground.			
4	OUT	Analog output signal.			

Functional Block Diagram



Specifications

 $(T_A = +15^{\circ}C^{2}+25^{\circ}C, V_{DD} = +1.8V, unless otherwise noted.)$

PARAMETER	Symbol	TEST CONDITIONS	MIN	ТҮР	ΜΑΧ	UNIT
Directivity				Omni		
Supply Voltage	V_{DD}		1.5		3.6	V
Current Consumption	I _{DD}				200	μΑ
Sensitivity (Note)		1kHz, 94dB SPL	-43	-42	-41	dBV
Signal-to-Noise-Ratio	SNR			59		dB
Equivalent Input Noise	EIN			35		dBA SPL
Total Harmonic Distortion	THD	105dB SPL			3	%
Power Supply Rejection Ratio	PSRR	217Hz, 100mV Vp-p, square wave on V _{DD}		65		dB
Maximum Acoustic Input				120		dB SPL
Output Impedance	Zout			200		Ω
Output DC Offset				0.75		V
Output Current Limit				90		μA
Polarity				Noninverting		

Note: Base on BK sound test system.

Typical Performance Characteristics





Reliability Tests

The microphone sensitivity after stress must deviate by no more than ±3dB from the initial value.

1.Heat Test, Operational		Temperature: 85±3°C
		Humidity: 85±5%RH
		Duration: 12 hours
		Voltage: Applied
2.Cold Test, Operational	I	Temperature: -40±3°C
		Duration: 12 hours
		Voltage: Applied
3.Heat Test, Non-Operat	tional	Temperature: 85±3°C
		Humidity: 50±5%RH
		Duration: 96 hours
	_	Voltage: Not Applied
4.Cold Test, Non-Operat	ional	Temperature: -40±3°C
		Duration: 96 hours
		Voltage: Not Applied
5.Condensation Test, No	on-Operational	Temperature: 25±3°C and 55±3°C
		Humidity: 95±5%RH
		Duration: 1 hours each, during 10 minutes
		ramp, 45 cycles
		Voltage: Not applied
6.Temperature Cycling,	Non-Operational	Temperature: -40±3°C and 85±3°C
		Hum <mark>idit</mark> y: 50 ± 5% RH
		Duration: 2 hours each, during 6 hours
		ramp, 5 cycles
		Voltage: Not applied
7.Thermal Shock Test, N	on-Operational	Temperature: -40±3°C and 85±3°C
		Duration: 30 minutes each, during 5
		minutes ramp, 256 cycles
		Voltage: Not applied
8.Free Fall Test 1.5m		Placed inside test fixture and dropped on
		concrete from height 1.5m.
		(1)3 times by 6 surfaces
		(2)1 times by 12 edges
		(3)1 times by 8 corners
9.Random Vibration		Temperature: 23±5°C
		Humidity: 35~70% RH
		Duration: 2 hours each axis(X,Y,Z)
		Power Spectral Density:
		5Hz 0.10m2/s3(=1.0391*10-3g2/Hz)
		12Hz 2.20m2/s3(=22.8602*10-3g2/Hz)
		20Hz 2.20m2/s3(=22.8602*10-3g2/Hz)
		200Hz 0.04m2/s3(=0.41534*10-3g2/Hz)
		200Hz 0.04m2/s3(=0.41564*10-3g2/Hz)
10.Repeated Low Level	Free Fall Test	Placed inside test fixture and dropped on
		rubber mat from height of 10cm.
		Each face 2500 times(Total 6 faces, 15000times)
11.1m Reneated Rotatin)g	Placed inside test fixture and dronned on steel
Free Fall	·0	sheet from height of 1 0m
		100 times(all faces)
		Rotation speed of harrel: 10~12 falls/minute
12 Free Fall Test for mas	ter hov	Corner drop: Each Corner 1 time
		Edge dron: Each Edge 1 time
		Luge urop. Each Lace 1 time
		race urop: Each race I time



ZTS6411

13.Random Vibration for master box	Sinusoidal wave vibration
	Frequency: 5~50Hz
	Acceleration:7.4m/s2(0.76G)
	Sweep speed:9Hz/min(5~50Hz, one way 5 min)
	Test duration: Direction of Face 1-3 20min
	Direction of Face 2-4 20min
	Direction of Face 5-6 20min
	Sample and direction of vibration : 1 direction
	for 1 sample
	Package on vibrating table: Free
14.Substrate bending Test	Deflection: 3mm
	Rate: 0.5mm/sec
15.Adhesion	Load: 10 N
	Duration: 10 seconds
16.Electrostatic Discharge Test	Capacitance: 150pF
	Resistance: 330Ω
	Duration: 10 times
	Air Discharge: Level 3(+/-8kV)
	Direct contact discharge: Level 1 (+/-2kV)
17.Human Body Model	2000 Volts (100pF,1500Ω)
18.Charged Device Model	500 Volts
19.Self alignment effect	Displacement: 0.15mm

MECHANICAL SPECIFICATIOPNS







ITEM	DIMENSION	TOLERANCE	UNITS		
Length (L)	3.760	±0.100	mm		
Width (W)	2.950	±0.100	mm		
Hoight (H)	1 200	+0.100			
neight (n)	1.300	-0.150	IIIII		
Acoustic Port (AP)	Ø0.500	±0.050	mm		

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RECOMMENDED CUSTOMER LAND PATTERN

The recommended PCB land pattern for the ZTS6411 should have a 1:1 ratio to the solder pads on the microphone package. Care should be taken to avoid applying solder paste to the sound hole in PCB. The dimensions of suggested solder paste pattern refer to the land pattern **which should be shrunk by 0.025 per side**.



WATERPROOF MEMBRANE

	Product Information			
performance		series ZTW 325		
Minimum instantaneous water entry pressure		1.0 bar		
IP rating		IP68		
Comparative water spray efficiency		85%		
Maximum transmission loss (max value 200-5000Hz)		<1dB		
Material type		PET-Nonwoven		
Material color		taupe		
Typical thickness		0.15mm		
temperature range	-40°C to 300°C			
Material characteristic		Oleophobic		
	3M-9079			
	characteristics	0.002 in. (0.05 mm) thick high double coated non-woven high temperature acryl ic adhesive		
Adhesive type	Release Liner	0.0036 in. (0.09 mm) thickheat resistant liner heat resistant liner		
	Color	clear		
	Temperature tolerance (Short term)	Adhesive : 530°F (300°C) Liner : 500°F (260°C)		
	Temperature tolerance (Long term)	Adhesive : 350°F (175°C) Liner : N/A		
RoHS	Meets threshold require	ments		
Note. High temperatures may cause produce of	olor changes, but without	losing the waterproof feature.		



SOLDER FLOW PROFILE



Stage	Temperature Profile	Time (maximum)
Pre-heat	+170°C ~ +180°C	120sec
Supply Voltage	> +230°C	100sec
Peak	+260°C maximum	30sec

IP68 Standard And Appearance

Item						
Hole Size	Sound Hole: Φ =0.50mm					
Picture		<u>20µm</u>				
Structure						
	Length(L)	3.76 ± 0.100 mm				
Dimension	Width(W)	2.95 ± 0.100 mm				
	Height(H) 1.30 + 0.100/-0.150 mn					

Operating Instructions

Operating Instruction							
Document NO.	14091201	Date	20140912	Page	2	Version	A/0
Part NO.	ZTS6411 (ZTS325)	Name	Paste Waterproof	Туре	Detection	Staffing	2
		_					
Item	Material	Code	Material	Name	Mate	Material Spec.	
1	21W32500010)	ZTW325		1000mm*10	J00mm*0.15mm	IPCS
2							
5			Description			Restrict	on
	Check station	and surface	cleaning of proc	luct			
Inspection	Check materia	l attribute.					
Procedures	Check for Defe	ects in the f	inished Product.				
	1 · Check the	quality of t	he material, for e	example mate	rial		
	attribute, surfa	ace cleaning	g.	·			
	2 · Chopping	film of test	samples and pos ⁻	ted on the be	arer.	Ensure no leakage	
	3 · Injected w	ater in the	vertically contain	er, ensure a h	igh degree		
	of 1.5M.				X		
	4 · Immersed	not less tha	an 30 minutes for	r testing samp	le in the		
Processes	container and	observe wł	nether leakage.				
110003503	5 · Three high	-temperatu	ire treatment of	waterproof m	embrane,	No abnormality in	the surface,
	observe the su	urface of the	e products is abn	ormal.		ex: no unglued.	
	6. The reflow	monomer i	nto a 1.5M conta	iner and ensu	re that the		
	test time is no	t less than 3	30 minutes.				
	7 · Conducted acoustic test system validation of testing monomer Verify electrical characteristics						
	sample. and Frequency response test.						
	8 · Check and correct, into to the process.						
Introspection			.5.				
Testing Process							
						Õ	
Test	1 · Chopped t	he Waterpr	oof, posted on th	ne bearer.			
Conditions	2 · Filled with	water in a	height of 1.5m d	epth's contair	ier.	20	
Monomer Testing	3 • Testing with a stopwatch. Until did not find leaks and testing time over 30 minutes 1 second. Image: A stopwatch of the stop						
	1 · Posted on	the Produc	ts after finished o	chopped of W	aterproof me	mbrane.	
Test	Image: Fest 2 · Three times reflow. Waterproof membrane without exception.						
Conditions	3 · The reflow	monomer	Into a 1.5M cont	ainer.	al the attine attin		
	4・ lesting wit	n a stopwa	tch. Until did not	tind leaks and	a testing time	over 30 minutes 3	seconds.



Equipment & P/N		Note.		
Equipment	P/N			
Container	ZTS1409001			
Waterproof membrane	ZTW325			
Chip	ZTS6411			
Stopwatch	ZTS1408102	Approved	Audit	
Acoustic test system	ZTS1410020	Approved	Auun	